

FDMC6296

November 2010

Single N-Channel Logic-Level Power Trench $^{{I\!\!R}}$ MOSFET 30 V, 11.5 A, 10.5 m Ω

Features

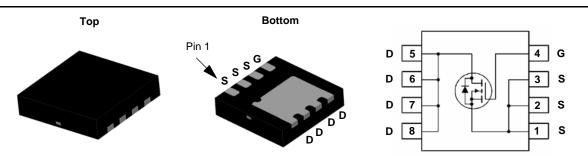
- Max $r_{DS(on)}$ = 10.5 m Ω at V_{GS} = 10 V, I_D = 11.5 A
- Max $r_{DS(on)}$ = 15 m Ω at V_{GS} = 4.5 V, I_D = 10 A
- Low Qg, Qgd and Rg for efficient switching performance
- RoHS Compliant

General Description

This single N-Channel MOSFET in the thermally efficient MicroFET Package has been specifically designed to perform well in Point of Load converters. Providing an optimized balance between $r_{DS(on)}$ and gate charge this device can be effectively used as a "high side" control swtich or "low side" synchronous rectifier.

Application

- Point of Load Converters
- 1/16 Brick Synchronous Rectifier



MLP 3.3X3.3

MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter				Ratings	Units
V _{DS}	Drain to Source Vo	Itage			30	V
V _{GS}	Gate to Source Vol	tage			±20	V
1	Drain Current	-Continuous	T _A = 25 °C	(Note 1a)	11.5	Α
D	-Pulsed				40	
D	Power Dissipation		T _C = 25 °C		2.1	14/
P _D	Power Dissipation		T _A = 25 °C	(Note 1a)	0.9	W
T _J , T _{STG}	Operating and Stor	age Junction Temperatu	ire Range		-55 to +150	°C

Thermal Characteristics

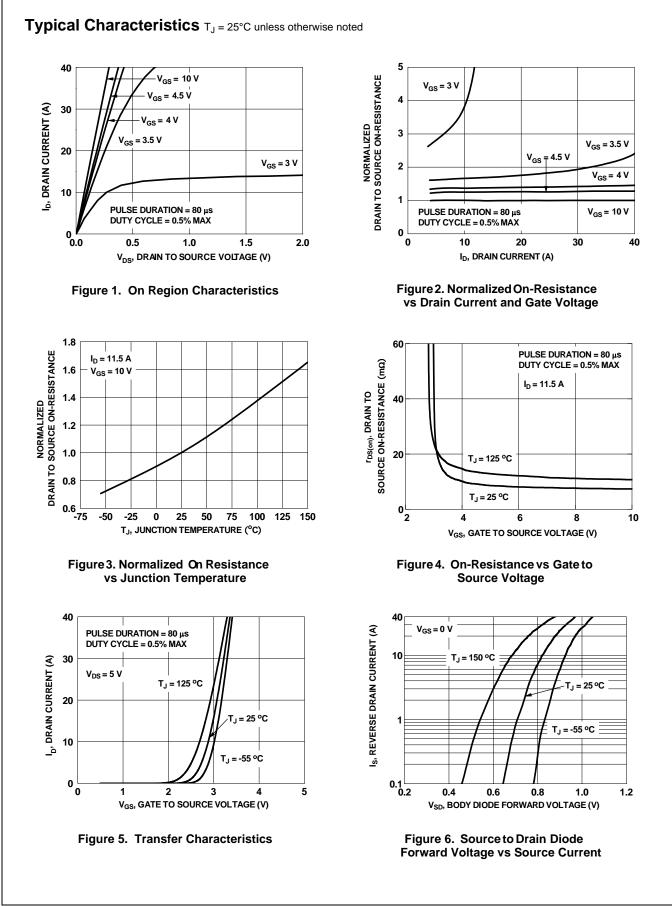
$R_{\theta JC}$	Thermal Resistance, Junction to Case	(Note 1)	3	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	53	C/vv

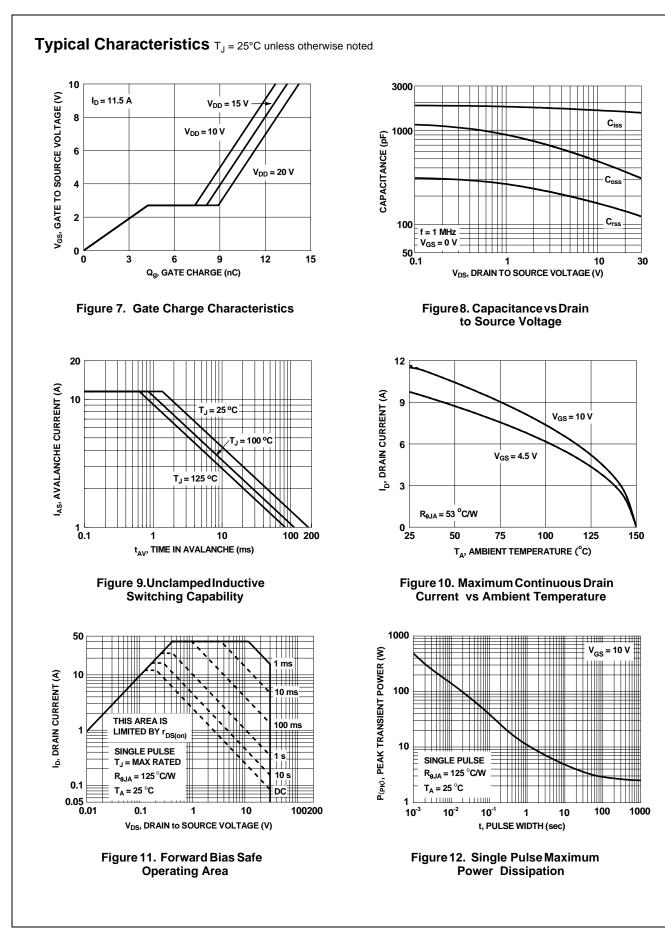
Package Marking and Ordering Information

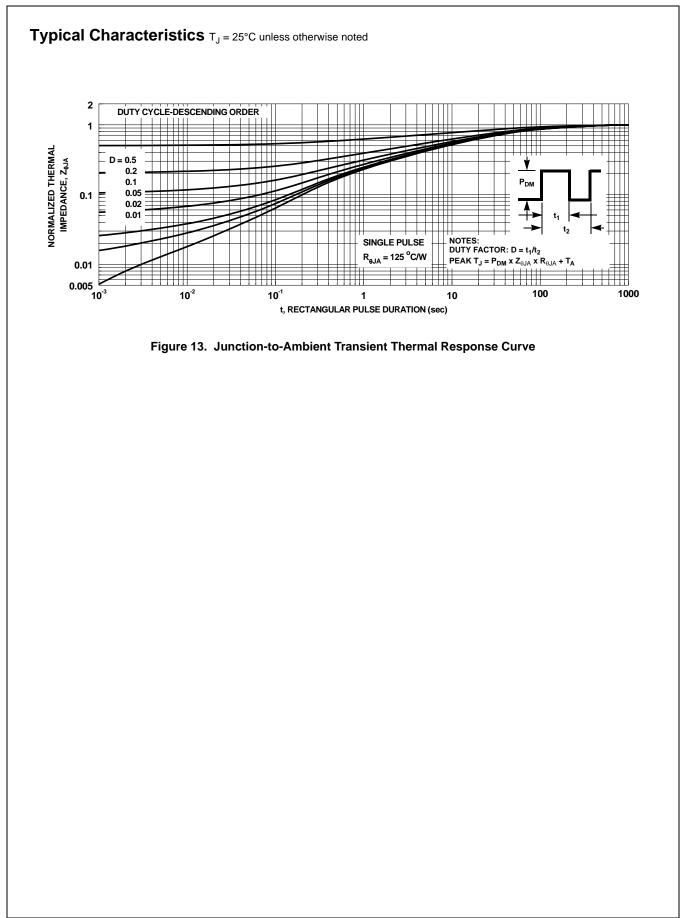
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMC6296	FDMC6296	MLP 3.3X3.3	13 "	12 mm	3000 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	30			V
∆BV _{DSS}	Breakdown Voltage Temperature		50			v
ΔT_{J}	Coefficient	I_D = 250 μ A, referenced to 25 °C		26		mV/°0
	Zero Gate Voltage Drain Current	$V_{DS} = 24 V, V_{GS} = 0 V$			1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			±100	nA
on Chara	cteristics					
				1.0	0	
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A1$		1.8	3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_{.l}}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 250 $\mu A,$ referenced to 25 °C		-6		mV/°0
<u> </u>		V _{GS} = 10 V, I _D = 11.5 A		8.7	10.5	
r _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$		10.6	15	mΩ
00(01)		V _{GS} = 10 V, I _D = 11.5 A, T _J = 125 °C		13	17	
9 _{FS}	Forward Transconductance	$V_{DD} = 5 V, I_D = 11.5 A$		49		S
		- I	L. L.		1	
•	Characteristics				1	
C _{iss}	Input Capacitance	— V _{DS} = 15 V, V _{GS} = 0 V,	1610		2141	pF
C _{oss}	Output Capacitance	f = 1 MHz		406	540	pF
C _{rss}	Reverse Transfer Capacitance			150	225	pF
R _g	Gate Resistance	$V_{GS} = 0 V, f = 1 MHz$		0.9		Ω
Switching	g Characteristics					
t _{d(on)}	Turn-On Delay Time		10		20	ns
t _r	Rise Time	V _{DD} = 15 V, I _D = 1.0 A,	31		0	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		27	43	ns
t _f	Fall Time		81		6	ns
Q _{g(TOT)}	Total Gate Charge at 5V	V _{GS} = 5 V	14		19	nC
Q _{gs}	Total Gate Charge	$V_{DD} = 15 V,$		4n		С
Q _{gd}	Gate to Drain "Miller" Charge	I _D = 11.5 A		4		nC
Drain Sau	urce Diode Characteristics					
					1.0	
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2 A$ (Note 2)	20	0.7	1.2	V
t _{rr}	Reverse Recovery Time	— I _F = 11.5 A, di/dt = 100 A/μs	30	22		ns
Q _{rr}	Reverse Recovery Charge			22		nC
Notes: R _{6JA} is determ the user's boa	nined with the device mounted on a 1in ² pad 2 oz copper particularity design.	nted on a	b. 12	5 ° C/W wh	e R _{θCA} is de en mo unted d of 2 oz cop	on
2. Pulse Test: Pu	ΔΟΟΟΟ ΔΟΟΟΟ Jlse Width < 300 μs, Duty cycle < 2.0%.	00000				
2. 1 000 1001 10						

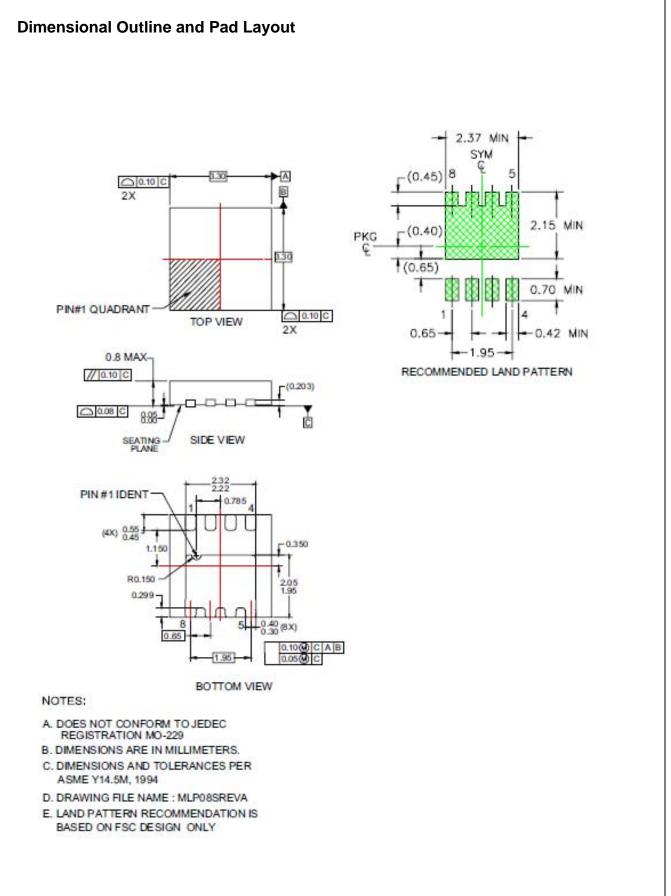
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